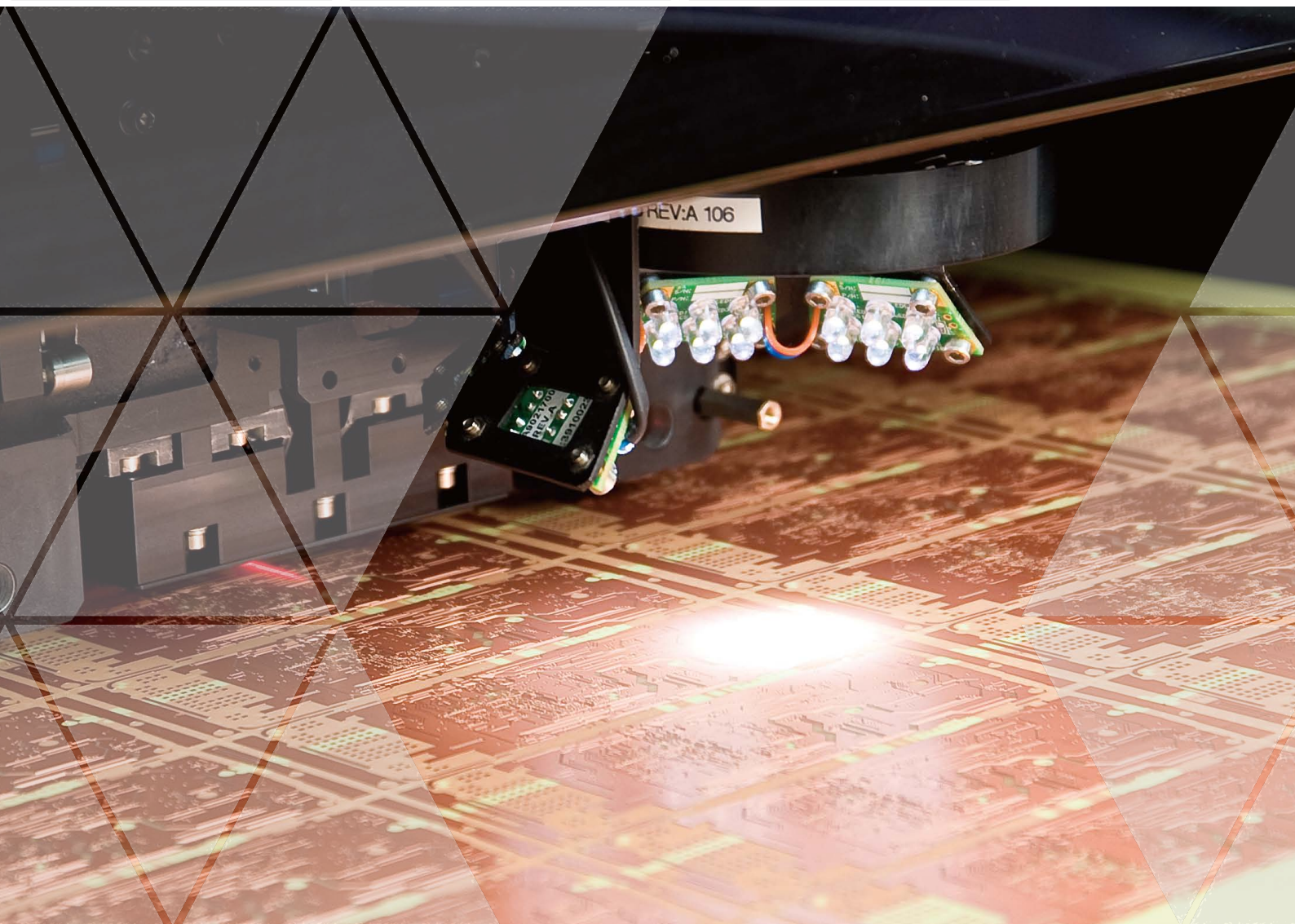


NOVA⁸⁰⁰



NOVA 800

PCB technology	Down to 50µm line/space
Throughput	Up to 265 sides/hour, 18" × 24" (457mm × 610mm)
Panel Size (maximum)	30" × 26" (762mm × 660mm)
Panel Thickness Range	1mil - 300mil (0.025mm - 7.6mm)
Panel Types and Designs	Inner and outer layers, build-up and sequential lamination layers including Signal, Mix and P&G, Cross-Shield
Materials Inspected	All copper foil types; Plated copper; Gold Plating
Detectable Defect Types	Open and short circuit, Nick, Protrusion, Mouse-bite, Pinhole, Island, Dish-down, Line/Space width violation, Annular ring violation, Extra and Missing features
Reference Source Data	CAM
Tooling	Pin-less
Operating System	Windows 7™ 64bit
Detection and set-up engine	Powered by Spark™
AMHS	The NOVA can be connected to front end AMHS
Verification and Repair Methods	Offline verification station
Dimensions	Height - 68.5" (174cm) Width - 67.7" (172cm) Depth - 93.3" (237cm) Weight - 1550Kg Power - 200±10%VAC; 50/60Hz; 2.5Kw
Compressed Air	6ATM, 1L/min
Temperature and Humidity	22±3°C; 50±10%RH

Optional Features	CDB/CDBIC – defects classification and virtual defects mapping WVS – virtual verification system
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Powered by Spark™

- Superior detection
- Lowest false calls rate
- Simple and quick setup
- Fast adaptation cycle



Powered by Microlight™

Advanced illumination technology provides:

- Flexible light coverage to detect fine shorts and dishdowns
- A full spectrum of waves' length suitable to all type of materials
- Adaptability for special applications

